



pkg. wt. part no.  
700 0.5 g 46.111.1001.50

ENEC Rating 9A / 320V  
URus Rating: 9A / 300V  
cUR Rating: 3A / 300V

**SMD Push through terminal block - 1 pole**  
**For wiring below the PCB / metal work**  
Solder fixing

Housing: PPA  
Contacts: Cu alloy

Approval: additional cURus

- No tools required! Wires can be released by twisting and pulling the wire simultaneously.
- Terminal block and ballast on same working level
- Note 1: Maximum thickness of PCB and heatsink should not exceed 3.6 mm
- Note 2: Recommendation for opening in heatsink is shown with minimum diameter. For other shaped pockets in heatsink the minimum creepage and clearance distances and manufacturing tolerances have to be considered.
- Note 3: Recommended dimension for opening in PCB
- Note 4: Recommended dimension for solder mask
- Note 5: For metal core PCBs the minimum creepage distance has to be guaranteed
- Note 6: Recommended pick & place area #1
- Note 7: Recommended pick & place area #2 inside of the connector. Max. diameter of nozzle is 2.5 mm.
- Note 8: Distance from center of mass to pick and place area #1 and #2
- General note: It is recommended to make an electrical connection between both poles of each polarity on the solder mask

LED-LINE	U <sub>imp</sub> 2,5 kV			
			0.20-0.75 mm <sup>2</sup>	0.20-0.75 mm <sup>2</sup>